

Features

- True RMS-To-DC Conversion
- Computes RMS of AC and DC Signals
- 600mV full scale
- Wide Response :

 ♦ 1MHz 3dB Bandwidth for V_{RMS} >
 100mV_{RMS}
- Single or Dual Supply Operation
- Power Down Function: Quiescent current reduction from 1.2mA to 5uA
- Buffered Voltage Output
- 14-lead SOIC (150mil width)

ES5 True RMS-to-DC Converter

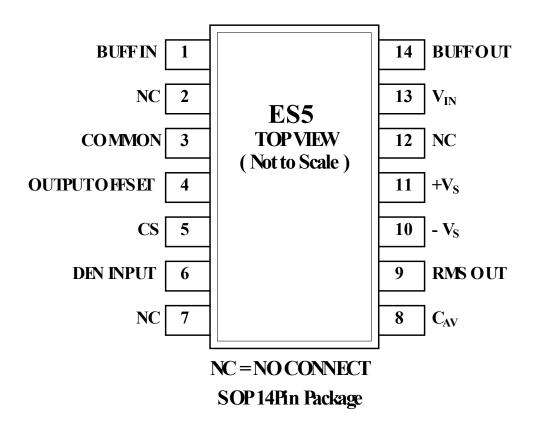
Description

The ES5 is a true RMS-to-DC converter. It accepts low-level input signals from 0 to 600 mV_{RMS} complex input waveforms. It can be operated form either a single supply or dual supplies. The device draws less than 1.2 mA of quiescent supply current, furthermore, a chip select pin is provided to power-down mode of the device, making it ideal for battery-powered applications.

Application

- * Digital Multi-Meters
- * Battery-Powered Instruments
- * Panel Meter

Pin Assignment





Pin Description

Pin No	Symbol	Туре	Description
1	BUFF IN	Ι	Buffer Input
2	NC	-	No Connection
3	COMMON	G	Analog Common
4	OUTPUT OFFSET	0	Output Offset
5	CS	Ι	Chip Select
6	DEN INPUT	Ι	Denominator Input
7	NC	-	No Connection
8	C _{AV}	I/O	Averaging Capacitor Connection
9	RMS OUT	0	RMS Output
10	-Vs	Р	Negative Supply Rail
11	$+V_{S}$	Р	Positive Supply Rail
12	NC	-	No Connection
13	Vin	Ι	Signal input
14	BUFF OUT	0	Buffer Output

Absolute Maximum Ratings

Supply Voltage : Dual Supplies	±6V
Single Supply	+12V
Input Voltage :	<u>+</u> Vs
Power Dissipation (Package) SOIC :	450mW
Operating Temperature Range :	-40° C to $+85^{\circ}$ C
Storage Temperature Range :	-55°C to +150°C
Lead Temperature (Soldering, 10sec) :	300°C



Electrical Characteristics

1	$TA = +25^{\circ}C$,	$V_{S} = +3V$	-Vc = -3V	unless	otherwise	noted)
($IA - \pm 23 \cup$	$v_{S} - + 3v_{s}$	-vs 3v,	umess	otherwise	noted.)

PARAMETER	CON	IDITIONS	MIN	TYP	MAX	UNITS
Transfer Equation			Vout	= [avg.(Vi	N)2] ^{1/2}	
Averaging Time Constant	Figure 3			25		ms/ μ F C _{AV}
CONVERSION ACCU						
Total Error, Internal Trim					±0.5	mV ±% of
(Notes 1,2) Total Error vs. Temperature					±1.0 ±0.1	Reading mV ±% of
$(-40^{\circ}C \text{ to } + 85^{\circ}C)$					±0.1 ±0.01	Reading/°C
Total Error vs. Supply	+VIN=300mV - VIN=-300mV			30 100	150 300	μ V ±% of
DC Reversal Error	Vin= 600mV			±0.3		±% of Reading
Total Error, External Trim (Note 1)					±0.25 ±0.1	mV ±% of Reading
ERROR vs. CREST F/	ACTOR					
Additional Error (Note 3)	Crest Factor 1 to 2 Crest Factor = 3 Crest Factor = 6		Spe	cified Acc ±0.1 ±0.5	uracy	±% of Reading
FREQUENCY RESPO						
Bandwidth for 1% Additional Error (0.09dB)	VIN =10mV VIN =100mV VIN =600mV			11 90 200		KHz KHz KHz
±3dB Bandwidth	VIN =10mV VIN =100mV VIN =600mV			130 1 3		KHz MHz MHz
INPUT CHARACTERIS						
	Continuous RMS,	All Supplies		0 to 600		mVrms
Input Signal range	Peak Transient	±3.0V Supplies ±5V Supplies			2.2 5.0	Vрк
Input Resistance				6		ΚΩ
Input Offset Voltage					±0.5	mV
OUTPUT CHARACTE	RISTICS (Note 1	1)				
	Ta=+25℃	•			±0.5	mV
Offset Voltage (Vin=COM)	Ta =-40∼85 °C				±0.1	mV/°C
Output Voltage Swing	+3V, -3V Supplies			2.2		V
Output Current			5			mA
Short-Circuit Current				18		mA
Output Resistance	Chip Select High Chip Select Low			0.5 100		Ω Κ Ω
DENOMINATIOR INPL	JT					
Input Range				0 to 2		V
Input Resistance				25		kΩ
Offset Voltage				±0.2		V
BUFFER AMPLIFIER					I	
Input and Output Voltage Range			-Vs to (+Vs-1.8V))	V
Input Offset Voltage				±0.8	±1.5	mV
Input Current				±50	-	nA
Input Resistance				10 ⁸		Ω
Output Current					5	mA
Short-Circuit Current				20	-	mA
Small-Signal Bandwidth				1		MHz
Slew Rate (Note 5)				5		V/μs
	1			5		•1 μ Ο



Electrical Characteristics (continued)

$(TA = +25^{\circ}C, Vs = +3V, -Vs = -3V, unless otherwise noted.)$

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Power SUPPLY					
Dual Supplies		±2.5		±6	V
Standby Current	Connect CS to –Vs and Pin4 is connected to COMMON (Figure.1).			2	μA
Quiescent Current (Note 6)			1		mA

Note 1: Accuracy is specified for 0 to 600mV, 1kHz sine-wave input. Accuracy is degraded at higher RMS signal levels.

Note 2: Measured at pin9 (RMS OUT), with pin 4 tied to COMMON.

Note 3: Error vs. crest factor is specified as an additional error for 300mV_{RMS} rectangular pulse input, pulse width = 200 μ s.

Note 4: Input voltages are expressed in volts V_{RMS}

Note 5: With 10 k $\Omega\,$ external pull-down resistor from pin 14 (BUFF OUT) to – Vs.

Note 6: With BUF input tied to COMMON.



ES5 True RMS-to-DC Converter

Standard Connection

The ES5 is simple to connect for a majority of rms measurements. In the standard rms connection shown in Figure 1, only an external capacitor is required to set the averaging time constant. In this configuration, the ES5 computes the True RMS value of any input signal. The magnitude of an averaging error is dependent on the value of the averaging capacitor, is existed at lower frequencies. For example, if the filter capacitor, C_{AV} , is 4.7µF, the error is 0.3% at 10Hz. To measure ac signal, the ES5 can be ac-couples by adding a capacitor in series with the input, as shown in Figure 1.

The performance of the ES5 is tolerant of minor variations in the power supply voltages; however, if the supplies used exhibit a considerable amount of high frequency ripple, it is advisable to bypass both supplies to ground through a 0.1μ F ceramic disc capacitor places as close to the device as possible.

The output signal range of the ES5 is a function of the supply voltages, the output signal can be used buffered or nonbuffered, depending on the characteristics of the load. If no buffer is needed, tie the buffer input (Pin 1) to common. The output of the ES5 is capable of driving 5mA into a $2K\Omega$ load without degrading the accuracy of the device.

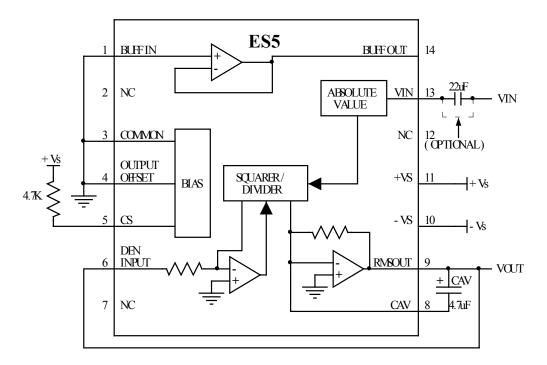


Figure 1. Standard connection for ES5



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High-Accuracy Adjustments

The accuracy of the ES5 can be further improved by the external trimming scheme as shown in Figure 2. The input should be grounded and R1 adjusted to give 0V output offset from pin 9. Alternatively, R1 could be adjusted to give the correct output with the lowest expected value of VIN. The R4 is in series with the pin13 to lower the range of the scale factor. Connect the desired full scale to VIN by using a DC or AC signal (ex. $500mV_{RMS}$), and R3 is trimmed to give the correct value for a calibrated signal.

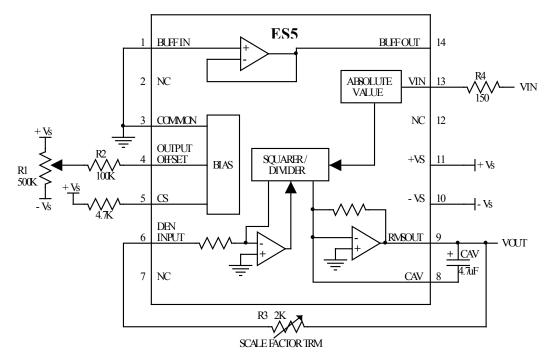


Figure 2. Optional External Gain and Offset Trims

Chip Select

The ES5 provides a chip select pin (Pin 5). To enable the device, this pin must be connected to +Vs. If it is connected to -Vs or floated, the device will enter power-down mode. The current it draws at this mode is less than 10uA. (Figure 1.)



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Choosing the Averaging Time Constant

The ES5 computes the RMS value of AC and DC signals. At low frequencies and DC, the output tracks the input exactly; at higher frequencies, the average output approaches the RMS value of the input signal. The actual output differs from the ideal by an average (or DC) error plus some amount of ripple.

The DC error term is a function of the value of C_{AV} and the input signal frequency. The output ripple is inversely proportional to the value of C_{AV} . Waveforms with high crest factors, such as a pulse train with low duty cycle, should have an average time constant chosen to be at least ten times the signal period.

Using a large value of C_{AV} to remove the output ripple increases the setting time for a step change in the input signal level.

The primary disadvantage in using a large C_{AV} to remove ripple is that the settling time for a step change in input level is increased proportionately. A better method to reduce the settling time and ripple is to use a post filter. A suggested circuit is shown in Figure 3. The 1-pole or 2-pole filter configuration allows a smaller C_{AV} . With post filter, the value of C_{AV} should be just large enough to give the maximum dc error at the lowest frequency of interest. And the output ripple will be removed by the post filter.

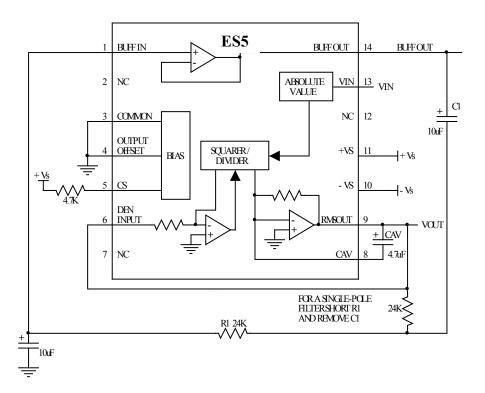
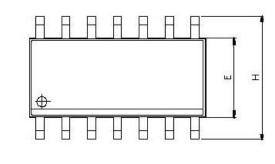


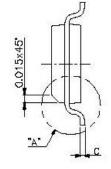
Figure 3. 2-Pole Filter

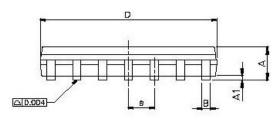


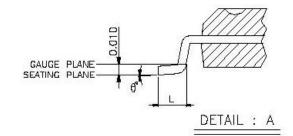
Packaging

1.14 Pin SOP Package









2. Dimension Paramenters

SYMBOLS	MIN.	NOM.	MAX.
A	0.058	0.064	0.068
A1	0.004	-	0.010
B	0.013	0.016	0.020
С	0.0075	0.008	0.0098
D	0.336	0.341	0.344
E	0.150	0.154	0.157
ę	(-)	0.050	-
H	0.228	0.236	0.244
Ê	0.015	0.025	0.050
0°	0"	in e:	8"

NOTES: 1.JEDEC OUTLINE : MS-012 AB

2.DIMENSIONS "D" DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.MOLD FLASH, PROTRUSIONS AND GATE BURRS SHALL NOT EXCEED .15mm (.006in) PER SIDE.

3.DIMENSIONS "E" DOES NOT INCLUDE INTER-LEAD FLASH, OR PROTRUSIONS, INTER-LEAD FLASH AND PROTRUSIONS SHALL NOT EXCEED .25mm (.010in) PER SIDE.